

2SB0943 (2SB943)

Silicon PNP epitaxial planar type

For power switching

Complementary to 2SD1268

■ Features

- Low collector to emitter saturation voltage $V_{CE(sat)}$
- Satisfactory linearity of forward current transfer ratio h_{FE}
- Large collector current I_C
- Full-pack package which can be installed to the heat sink with one screw

■ Absolute Maximum Ratings $T_C = 25^\circ\text{C}$

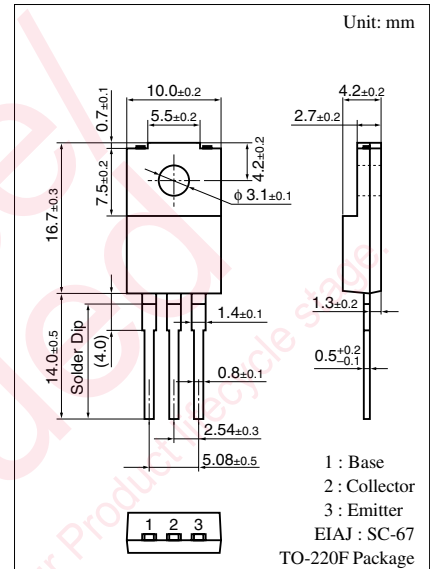
Parameter	Symbol	Rating	Unit	
Collector to base voltage	V_{CBO}	-130	V	
Collector to emitter voltage	V_{CEO}	-80	V	
Emitter to base voltage	V_{EBO}	-7	V	
Peak collector current	I_{CP}	-6	A	
Collector current	I_C	-3	A	
Collector power dissipation	$T_C = 25^\circ\text{C}$ $T_a = 25^\circ\text{C}$	P_C	30	W
			2	
Junction temperature	T_j	150	$^\circ\text{C}$	
Storage temperature	T_{stg}	-55 to +150	$^\circ\text{C}$	

■ Electrical Characteristics $T_C = 25^\circ\text{C}$

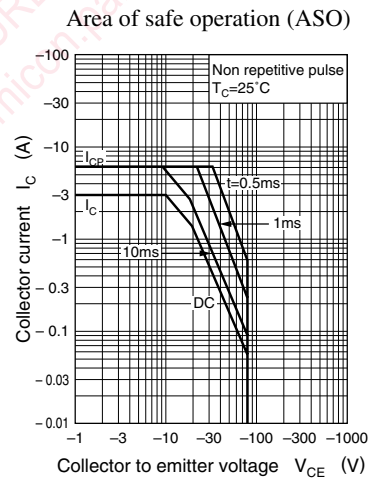
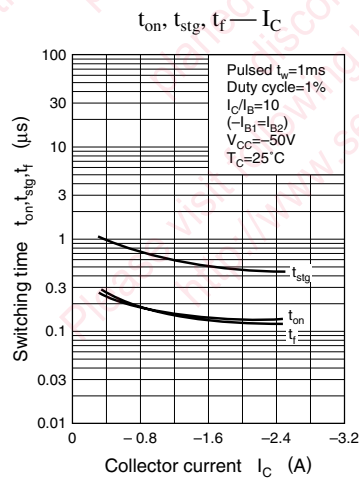
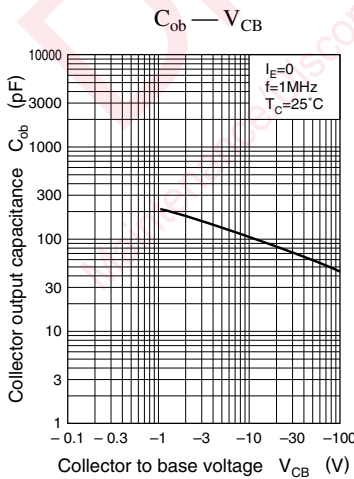
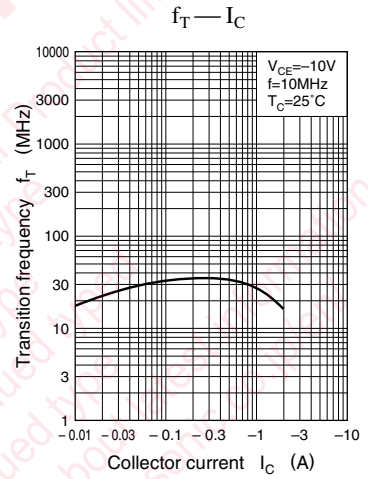
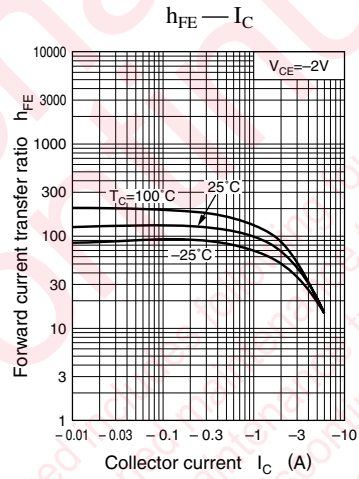
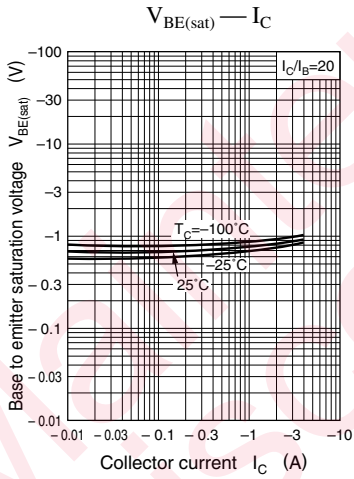
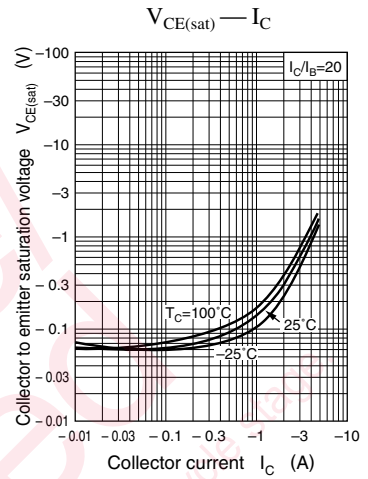
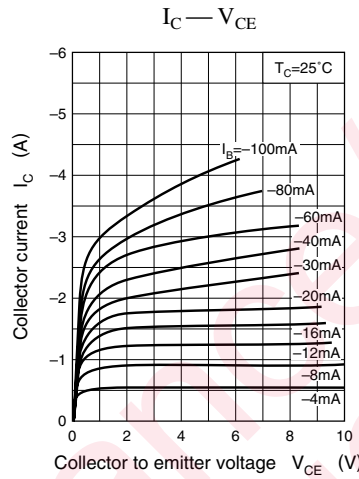
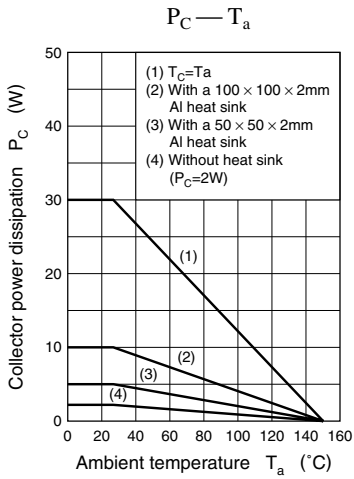
Parameter	Symbol	Conditions	Min	Typ	Max	Unit
Collector cutoff current	I_{CBO}	$V_{CB} = -100\text{ V}, I_E = 0$			-10	μA
Emitter cutoff current	I_{EBO}	$V_{EB} = -5\text{ V}, I_C = 0$			-50	μA
Collector to emitter voltage	V_{CEO}	$I_C = -10\text{ mA}, I_B = 0$	-80			V
Forward current transfer ratio	h_{FE1}	$V_{CE} = -2\text{ V}, I_C = -0.1\text{ A}$	45			
	h_{FE2}^*	$V_{CE} = -2\text{ V}, I_C = -0.5\text{ A}$	90		260	
Collector to emitter saturation voltage	$V_{CE(sat)}$	$I_C = -2\text{ A}, I_B = -0.1\text{ A}$			-0.5	V
Base to emitter saturation voltage	$V_{BE(sat)}$	$I_C = -2\text{ A}, I_B = -0.1\text{ A}$			-1.5	V
Transition frequency	f_T	$V_{CE} = -10\text{ V}, I_C = -0.5\text{ A}, f = 10\text{ MHz}$		30		MHz
Turn-on time	t_{on}	$I_C = -0.5\text{ A}, I_{B1} = -50\text{ mA}, I_{B2} = 50\text{ mA}$		0.3		μs
Storage time	t_{stg}			1.1		μs
Fall time	t_f			0.3		μs

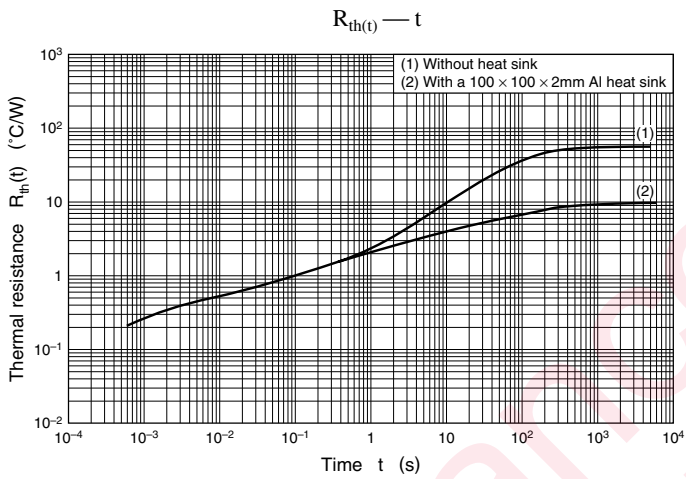
Note) *: Rank classification

Rank	Q	P
h_{FE2}	90 to 180	130 to 260



Note.) The Part number in the Parenthesis shows conventional part number.





Maintenance/Discontinued

Discontinued includes following four Product lifecycle stage.
 planned maintenance type
 maintenance type
 planned discontinued type
 discontinued type
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